

Quantum Design electrical transport
user training seminar

part 2: experiment design

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outline of seminar

- which transport option to use?
 - Resistivity, ACT, ETO
- sample preparation
- attaching leads to your sample
- mounting sample on the puck
 - examples for certain measurements
- inserting puck in PPMS
 - grounding considerations
- measurement sequence examples

which transport option to use?

- 3-channel **Resistivity** (Res. • I-V • voltmeter)
 - sweet spot: $1 \Omega - 1 \text{ M}\Omega$
 - measures continuously (<1 sec. per pt.)
 - no diagnostics of data quality or of current source railing
- 2-channel **AC Transport** (Res. • Hall • I-V • crit. curr.)
 - sweet spot: $< \mu\Omega$ to $10 \text{ k}\Omega$
 - developed during high- T_c (max current=2 A; critical current)
 - data rate not as fast (DSP tasks take >1 sec.)
 - I-V and c.c. are DC measurements (best noise $\sim 50 \text{ nV}$)
- 2-channel **ETO** (Res. • dV/dI (dI/dV) • I-V (V-I))
 - sweet spots: $\mu\Omega - 10 \text{ M}\Omega$ (4-wire) and $2 \text{ M}\Omega - 5 \text{ G}\Omega$ (2-wire)
 - fast measurements again (continuous excitation mode)
 - two independent sources, meters

transport sample preparation

- regular plate geometry ideal
 - easy mounting of leads
 - accurate estimation of sample A/L
- homogeneous and isotropic sample assumed
 - sample cracks, voids, inclusions complicate interpretation of data
- we will need ohmic contact to sample
 - contacts must achieve metal-to-metal bond without insulating layers in between – methods are very sample-dependent!
 - metal (Au, Ag, Pt) contact pad evaporation, sputtering, or CVD can promote ohmic contact to sample underneath
 - Ag paint, sanding, chemical etching can also remove oxides
 - resulting surface should be clean of residue and oils before leads are attached

see Wikipedia article: “ohmic contact”.

attaching leads to the sample

- sample mounting methods – note that PPMS goes up to 400 K!
 - solder: easy, but does not stick to most samples; many solder formulations exist (alloys of In, Pb, Sb, Ag...)
 - ultrasonic soldering (In solder): iron has piezo that breaks oxide barriers
 - wire-bonding: **Au** or **Al** 25 micron wires; good contacts when they take; expensive and delicate equipment
 - **Ag, Pt** or **Au** paint: volatile matrix evaporates and leaves metal particles; little adhesion force; good electrical contact
 - **Ag** epoxy (2-part): stronger adhesion, bake sample >100 C
 - pressed **In** or **In-Ga** contacts: getting good bond is an art
 - spring-loaded pins: easy to mount/unmount sample but geometry fixed



Ag epoxy is known to become thermally insulating at low T and can sometimes become electrically insulating (it is a mixture of Ag particles and an insulating 2-part epoxy).

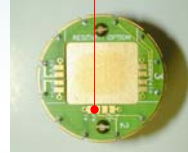
Spring-loaded pins also are sometimes prone to issues as insulating barriers can form between the pin and the sample.

placement of leads on sample

- standard 4-wire method
 - 4 distinct contacts along a line on the sample surface
 - current leads I+/I- at ends of sample, V+/V- in between
 - current flow is uniform where V+/V- are located
- van der Pauw method
 - uses 2 measurements to determine ρ directly
 - leads placed on *perimeter* of isotropic, homogeneous and uniform thickness sample
 - see PPMS Resistivity app. note 1076-304
- 2-wire method (only in ETO, for $R > 1 \text{ M}\Omega$)
 - uses I+ and V- leads ONLY
 - contact resistance can be high, but contacts must still be ohmic

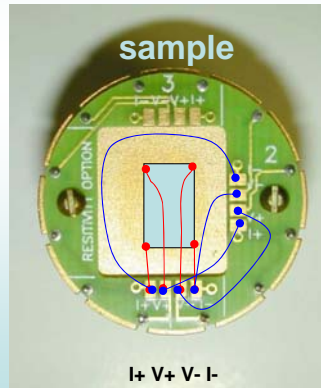
mounting sample to the puck

- sample must be insulated from the puck surface
 - Kapton tape
 - cigarette paper + varnish
 - insulating thin film substrate
- easiest to solder wires to pads on puck
- ground path from puck:
 - puck / sample chamber / PPMS / vacuum pump / wall
- ALL low-level measurements should be isolated from (noisy) ground

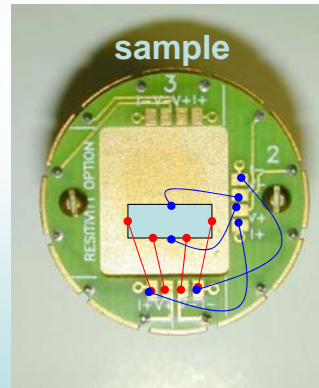


Resistivity (ETO) sample mounting

van der Pauw resistivity
using Ch.1 and Ch.2



Ch.1: resistivity
Ch.2 : Hall



Main point: it is easy to jumper wires from one set of pads to another rather than making multiple connection to the sample.

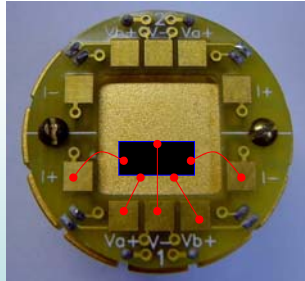
van der Pauw: for more info see PPMS app note 1076-304 on website www.qdusa.com

When one channel is measuring, the other channels are open circuit so they do not interfere.

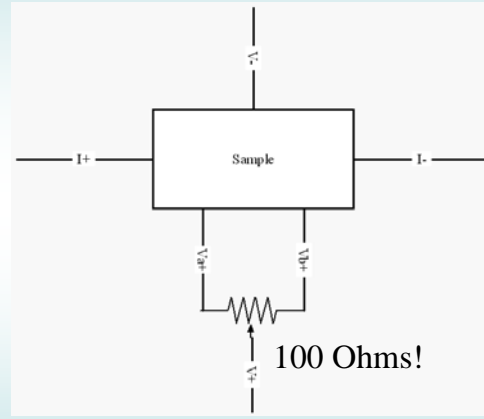
Another variant: Ch.1 and Ch.2 are van der Pauw, and Ch.3 is Hall.

ACT 5-wire Hall method

- must null voltage at zero field
- requires low R sample
 - 100 Ohm pot
- 4-wire also possible

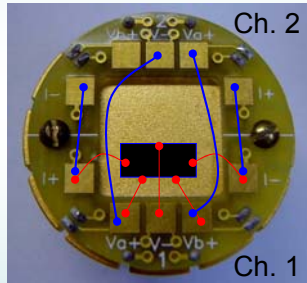


sample



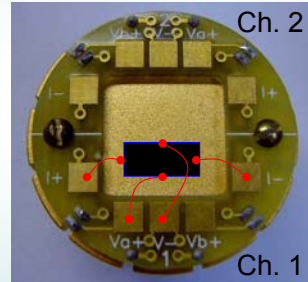
ACT: sample mounting

Ch.1: 5-probe Hall
Ch.2 : resistivity



sample

Ch.1: 4-probe Hall



sample

ACT: rotator sample mount

- one set of current leads shared between Ch.1 and Ch.2

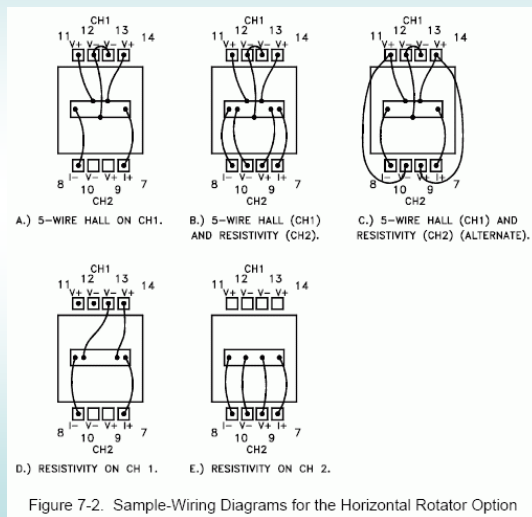


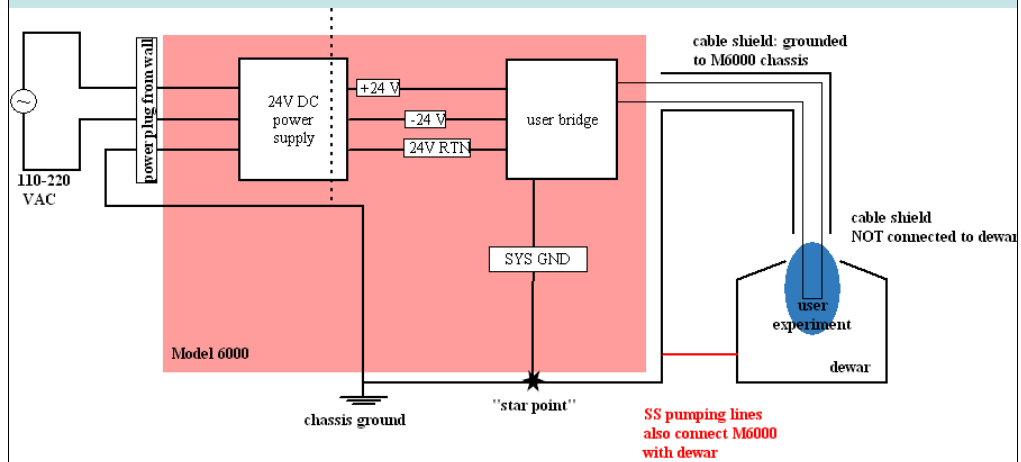
Figure 7-2 taken from ACT user manual.

verify/repair contacts on bench

- the most important applications issue with transport measurements!!
- test contacts with ohmmeter (DMM) after sample mounted on puck or rotator board
 - use puck test station P150
 - adapter provided for rotator boards
- is contact resistance R_{contacts} too high?
 - $R_{\text{measured}} = R_{\text{leads}} + R_{\text{contacts}} + R_{\text{DMMcontact}} + R_{\text{sample}}$
 - R_{leads} known for a given metal (Ag,Pt,Cu)
 - $R_{\text{DMMcontact}} \sim 0.2 \Omega$
 - R_{sample} estimated or measured with 4-probe DMM
- methods of lowering R_{contacts}
 - touch up with Ag paint, allow to dry
 - “sparking” (CAUTION!)
 - bipolar current source (~100 mA)
 - switching polarity will create high voltages across resistive junctions, sometimes breaks down oxide barriers

sometimes contacts are fine at 300 K but become insulating at low temperatures. Schottky (semiconductor-metal) barriers are often to blame.

(brief aside: grounding in PPMS)



- dewar singly-connected to ground through pumping line (red)
- experiment cable shield is grounded to electronics, not dewar
- if sample is ESD sensitive, then insert into PPMS by: 1) plug in all experiment cabling to PPMS, 2) turn on electronics but do not start measurements, 3) ground extraction tool (+you) to M6000 chassis during insertion

measurement sequence examples

- (Resistivity) scan excitation example.seq
 - scans on Ch.1 and Ch.2 from – to + currents, first sets up channels
 - Note Bridge Configuration must be ON
- (Resistivity) Ch.1 resistivity example.seq
 - sets up Ch.1 (turns off all others)
 - measures 100 points, each is avg of 4 measurements
 - Note Bridge Configuration “No Action” as bridge already set up
- (ACT) Hall vs Field.seq
 - measures Hall on Ch.1 and Ch.2 from -6 to +6 tesla
 - 103 Hz used for a.c. frequency; 17 Hz also found to be good, must determine best one for your lab by trying different ones (prime numbers, away from line freq. and harmonics)